# ECE 471 – Embedded Systems Lecture 31

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#### **Announcements**

- Class all remote (not feeling well)
- Have a good Thanksgiving break!
- Project update was due
- HW#10 will be posted after break
- Return your parts when you are done with them



#### **Definitions**

People often say Power when they mean Energy

- Dynamic Power only consumed while computing
- Static Power consumed all the time.
  Sets the lower limit of optimization



#### **Units**

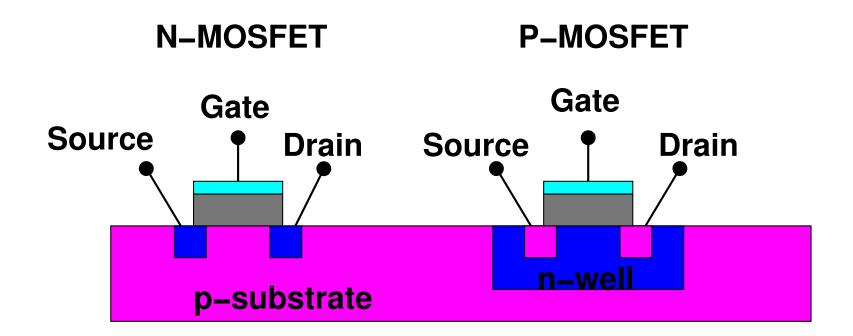
- Energy Joules, kWH (3.6MJ), Therm (105.5MJ), 1 Ton TNT (4.2GJ), eV  $(1.6 \times 10^{-19} \text{ J})$ , BTU (1055 J), horsepower-hour (2.68 MJ), calorie (4.184 J)
- Power Energy/Time Watts (1 J/s), Horsepower (746W), Ton of Refrigeration (12,000 Btu/h)
- $\bullet$  Volt-Amps (for A/C) same units as Watts, but not same thing
- Charge mAh (batteries) need voltage to convert to Energy



# **CPU Power and Energy**



#### **CMOS** Transistors





### **CMOS Dynamic Power**

- $P = C\Delta V V_{dd} \alpha f$ Charging and discharging capacitors big factor  $(C\Delta V V_{dd})$  from  $V_{dd}$  to ground  $\alpha$  is activity factor, transitions per clock cycle f is frequency
- $\bullet$   $\alpha$  often approximated as  $\frac{1}{2}$ ,  $\Delta VV_{dd}$  as  $V_{dd}^2$  leading to  $P \approx \frac{1}{2}CV_{dd}^2f$
- Some pass-through loss (V momentarily shorted)



## **CMOS Dynamic Power Reduction**

How can you reduce Dynamic Power?

- Reduce C scaling
- Reduce  $V_{dd}$  eventually hit transistor limit
- Reduce  $\alpha$  (design level)
- $\bullet$  Reduce f makes processor slower



#### **CMOS Static Power**

- Leakage Current bigger issue as scaling smaller.
  Forecast at one point to be 20-50% of all chip power before mitigations were taken.
- Various kinds of leakage (Substrate, Gate, etc)
- ullet Linear with Voltage:  $P_{static} = I_{leakage}V_{dd}$



### Leakage Mitigation

- SOI Silicon on Insulator (AMD, IBM but not Intel)
- High-k dielectric instead of SO2 use some other material for gate oxide (Hafnium)
- Transistor sizing make only critical transistors fast;
  non-critical can be made slower and less leakage prone
- Body-biasing
- Sleep transistors



## **Total Energy**

•  $E_{tot} = [P_{dyanmic} + P_{static}]t$ 

• 
$$E_{tot} = [(C_{tot}V_{dd}^2\alpha f) + (N_{tot}I_{leakage}V_{dd})]t$$



### **Delay**

• 
$$T_d = \frac{C_L V_{dd}}{\mu C_{ox}(\frac{W}{L})(V_{dd} - V_t)}$$

- ullet Simplifies to  $f_{MAX} \sim rac{(V_{dd} V_t)^2}{V_{dd}}$
- ullet If you lower f, you can lower  $V_{dd}$



#### Thermal Issues

- Temperature and Heat Dissipation are closely related to Power
- If thermal issues, need heatsinks, fans, cooling



### Metrics to Optimize

- Power
- Energy
- MIPS/W, FLOPS/W (don't handle quadratic V well)
- $\bullet$  Energy \* Delay
- $Energy * Delay^2$



#### **Power Optimization**

 Does not take into account time. Lowering power does no good if it increases runtime.



## **Energy Optimization**

 Lowering energy can affect time too, as parts can run slower at lower voltages



# Energy Delay – Watt/t\*t

- Horowitz, Indermaur, Gonzalez (Low Power Electronics, 1994)
- Need to account for delay, so that lowering Energy does not made delay (time) worse
- Voltage Scaling in general scaling low makes transistors slower
- Transistor Sizing reduces Capacitance, also makes transistors slower



- Technology Scaling reduces V and power.
- Transition Reduction better logic design, have fewer transitions
   Get rid of clocks? Asynchronous? Clock-gating?
- Example with inverse ED (higher better):

Alpha 21064	SPEC=155	Power=30W	SPEC*SPEC/W=800
PPC603	SPEC=80	Power=3W	SPEC*SPEC/W=2100



## Energy Delay Squared— E\*t\*t

- Martin, Nyström, Pénzes Power Aware Computing,
  2002
- Independent of Voltage in CMOS
- Et can be misleading
  Ea=2Eb, ta=tB/2
  Reduce voltage by half, Ea=Ea/4, ta=2ta, Ea=Eb/2, ta=tb
- Can have arbitrary large number of delay terms in Energy



#### product, squared seems to be good enough



### **Power and Energy Concerns**

#### Table 1: ATLAS 300x300 DGEMM (Matrix Multiply)

Machine	Processor	Cores	Frequency	ldle	Load	Time	Total Energy
Raspberry Pi	ARM 1176	1	700MHz	3.0W	3.3W	23.5s	77.6J
Gumstix Overo	Cortex-A8	1	600Mhz	2.6W	2.9W	27.0s	78.3J
Beagleboard	Cortex-A8	1	800MHz	3.6W	4.5W	19.9s	89.5J
Pandaboard	Cortex-A9	2	900MHz	3.2W	4.2W	1.52s	6.38J
Chromebook	Cortex-A15	2	1.7GHz	5.4W	8.1W	1.39s	11.3J



#### Questions

- Which machine consumes the least amount of energy?
  (Pandaboard)
- Which machine computes the result fastest?
  (Chromebook)
- Chromebook is a laptop so also includes display and wi-fi
- Consider a use case with an embedded board taking a picture once every 20 seconds and then performing a



300x300 matrix multiply transform on it. Could all of the boards listed meet this deadline?

No, the Raspberry Pi and Gumstix Overo both take longer than 20s and the Beagleboard is dangerously close.

• Assume a workload where a device takes a picture once a minute then does a 300x300 matrix multiply (as seen in Table 1). The device is idle when not multiplying, but under full load when it is. Over an hour, what is the energy usage of the Chromebook? What is the energy usage of the Gumstix?



Chromebook per minute:  $(1.39s \times 8.1W) + (58.61s \times 5.4W) = 327.75J$ 

Chromebook per hour: 327.75J \* 60 = 19.7kJ

Gumstix per minute:  $(27s \times 2.9W) + (33s \times 2.6W) = 164.1J$ 

Gumstix per hour: 164.1J \* 60 = 9.8kJ

# Easy ways to reduce Power Usage



#### **DVFS**

- Voltage planes on CMP might share voltage planes so have to scale multiple processors at a time
- DC to DC converter, programmable.
- Phase-Locked Loops. Orders of ms to change. Multiplier of some crystal frequency.
- Senger et al ISCAS 2006 lists some alternatives. Two phase locked loops? High frequency loop and have programmable divider?



 Often takes time, on order of milliseconds, to switch frequency. Switching voltage can be done with less hassle.



#### When can we scale CPU down?

- System idle
- System memory or I/O bound
- Poor multi-threaded code (spinning in spin locks)
- Thermal emergency
- User preference (want fans to run less)



## Measuring Power and Energy

- Sense resistor or Hall Effect sensor gives you the current
- Sense resistor is small resistor. Measure voltage drop. Current V=IR Ohm's Law, so V/R=I
- Voltage drops are often small (why?) so you made need to amplify with instrumentation amplifier
- Then you need to measure with A/D converter
- ullet P = IV and you know the voltage
- How to get Energy from Power?



### RAPL – Running Average Power Limit

- Estimated power provided by the CPU
- Small embedded system calculates it based on model
- Provided for turbo-boost and power capping

